



Product Change Notice

Micron PCN: 31283
Date: 7/25/2014

Type of Change:	Die Shrink, End of Life	
Title of Change:	EOL of Automotive, PLP, and Wafer 50nm DDR3 1Gb Parts (V68A)	
Description of Change:	Micron's 50nm 1Gb DDR3 (V68A) is being replaced by 30nm process node 1Gb DDR3 (V88A)	
Reason for Change:	Optimization of Manufacturing Efficiency	
Contact Information:	<u>Marketing Contact</u> SVEN EVERS Micron Semiconductor Prds SEVERS@MICRON.COM	<u>Engineering Contact</u> EITOKU SHIBA Micron Semiconductor Prds ESHIBA@MICRON.COM

Product Affected: V68A Automotive and PLP MPNs

<u>Affected Micron Part Number</u>	<u>Replacement Part Number</u>
MT41J64M16V68A3WC1	Contact Factory
MT41J128M8V68AWC1	Contact Factory
MT41J128M8JP-15E AIT:G	MT41K128M8DA-107 AIT:J
MT41J64M16JT-15E AIT:G	MT41K64M16TW-107 AIT:J
MT41J64M16JT-15E XIT:G	MT41K64M16TW-107 XIT:J
MT41J64M16JT-15E AAT:G	MT41K64M16TW-107 AAT:J

Method of Identification: Part Number

Micron Sites Affected: All Sites

New 30nm Timeline:

Qual Data Available: August 2014
Sample Available: September 2014
Product Ship Date: September 2014

Current 50nm Timeline:

Last Time Buy: 30-Sep-2015
Last Time Ship: 30-Sep-2016

Orders placed prior to the LTB date are subject to current inventory levels, which may vary based on market conditions and customer demand. Early orders are encouraged.